# aSM121 SIMISTOR™ TEMPERATURE SENSOR **ULTRA-LOW-POWER SILICON THERMISTOR**



## **New Release Specification**

#### **General Description**

The aSM121 is a high-precision, 3-lead CMOS silicon thermistor in an ultra-small leadless package that provides a cost-effective solution for applications requiring highaccuracy low-power temperature monitoring. The aSM121 functions in a way that is similar to a PTC thermistor. However, it is linear-calibrated, enabling application developers to directly interpret output voltage as temperature without complex compensation for nonlinearity.

The aSM121 output voltage ramp has a positive slope of 10mV/°C that is independent of supply voltage. The aSM121 has a guaranteed room temperature (25°C) accuracy of ±1°C. The aSM121 does not require external calibration - each device is calibrated at the factory.

#### **Features**

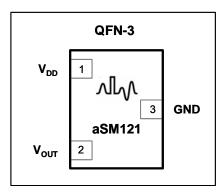
- Precision Calibrated to ±1°C at 25°C
- Temperature Range: -30°C to 125°C
- Extremely Linear Output Ramp: 10mV/°C
- 0°C Output: 0.50V
- Output Ramp is Calibrated to Degrees Celsius
- Low Operating Current: 14µA
- Operating Voltage Range: +2.7 V to +3.6V
- Non-linearity: ≤ 0.8°C
- 1.2mm x 1.5mm QFN Package

#### **Applications**

- Mobile Phones
- Mobile Communications Terminals
- Computers
- **Battery Management**
- FAX Machines/Printers/Copiers
- Portable Medical Instruments
- HVAC, Power Supply Modules
- Disk Drives
- **Automotive Control Circuits**

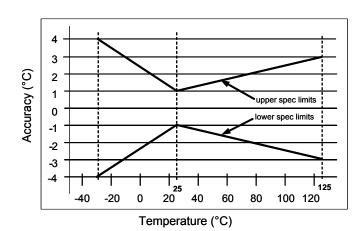
# **PRODUCT SPECIFICATION**

### **Pin Configuration**



Top view, contacts underneath, actual part marking below

#### **Accuracy vs Temperature**



# **Ordering Information**

Part Number	Package	Temperature Range	Part Marking	How Supplied
aSM121Q3	3-Lead QFN	-30°C to +125°C	Jm	3000 units on T&R

m - month / year code



# Absolute Maximum Ratings<sup>1</sup>

Pa	Rating		
Sup	+7V		
Out	V <sub>DD</sub> + 0.5V		
Continuous Current, any terminal		10mA	
Storage Te	-60°C to +150°C		
ESD <sup>2</sup>	Human Body Model	4000V	
	Machine Model	400V	
Thermal Resistance - Θ <sub>JA</sub>	QFN-3	TBD	
Lead Temp		260°C	

#### Notes:

- Absolute maximum ratings are limits beyond which operation may cause permanent damage to the device. These are stress ratings only; functional operations at or above these limits is not implied.
- 2. Human Body Model: 100pF capacitor discharged through a  $1.5k\Omega$  resistor into each pin. Machine Model: 200pF capacitor discharged directly into each pin.
- 3. These specifications are guaranteed only for the test conditions listed.

#### **Recommended Operating Ratings**

Symbol	Parameter	Min	Max	Units
$V_{DD}$	Supply Voltage	+2.7	+3.6	V
V <sub>OUT</sub>	Output Voltage	0	1.8	V
T <sub>A</sub>	Operating Temperature Range	-30	+125	°C

# Electrical Characteristics<sup>3</sup>

Limits apply for -40°C $\leq$ T<sub>A</sub> $\leq$ +125°C and V<sub>DD</sub>=+3.0V unless otherwise noted.

Parameter	Symbol	Conditions	Min	Тур	Max	Units
Accuracy <sup>4</sup>		T <sub>A</sub> =+25°C	-1	±0.5	+1	°C
		$T_A$ =-30°C ( $T_{MIN}$ )	-4	±1	+4	°C
		T <sub>A</sub> =+125°C (T <sub>MAX</sub> )	-3	±1	+3	°C
Non-linearity <sup>5</sup>				±0.8		°C
Supply Current - Output floating	I <sub>DD</sub>	T <sub>A</sub> =+25°C		14		
		-30°C≤T <sub>A</sub> ≤+125°C			15	μΑ
Output Sink Capability <sup>6</sup>	I <sub>OL</sub>	+2.7V < V <sub>DD</sub> < +3.6V	_	25		μΑ
Output Source Capability <sup>6</sup>	I <sub>OH</sub>	+2.7V < V <sub>DD</sub> < +3.6V		200		μΑ
Average Output Slope (Sensor Gain)	A <sub>OUT</sub>			10		mV/°C
Zero-Degree Output Voltage	V <sub>OUT0</sub>	T <sub>A</sub> =+0°C		500		mV
Room Temp Output Voltage	V <sub>OUT25</sub>	T <sub>A</sub> =+25°C		750		mV
Self Heating <sup>7</sup>		QFN-3		0.025		°C

#### Notes:

- 4. Accuracy (expressed in °C) = Difference between calculated output voltage and measured output voltage.

  Calculated output voltage = 10mV/°C multiplied by device's case temperature at specified conditions of temperature, voltage and power supply with an offset of 500mV (see Fig. 1).
- 5. Non-linearity is defined as the deviation of the output-voltage-versus-temperature curve from the best-fit straight line, over the device's rated temperature range.
- 6. Lowest output current should be targeted; higher currents result in more self-heating of the device.
- 7. Max Self Heating =  $\Theta_{JA}$  x ( $V_{DD}$  x  $I_{DD}$ ). Assumes a capacitive load.

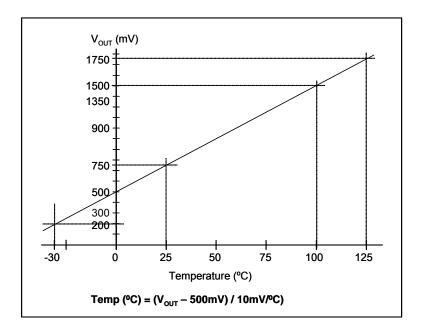


Figure 1. aSM121 Output Voltage vs. Temperature

#### **Mounting**

The aSM121 package provides good thermal conductivity to the surface to which it is soldered. It's low mass allows it to respond quickly to changes in board temperature. In this case, its temperature will be within about 0.02°C of the temperature of the surface it is attached to if the ambient air temperature is almost the same as the surface temperature. If the air temperature is much higher or lower than the surface temperature, the actual temperature of the aSM121 die will be at an intermediate temperature between the surface temperature and the air temperature.

To ensure good thermal conductivity, the backside of the aSM121 die is directly attached to the GND pin. The lands and traces to the aSM121 will, of course, be part of the printed circuit board, which is the object whose temperature is being measured. These printed circuit board lands and traces will not cause the aSM121's temperature to deviate from the desired temperature.

Alternatively, the aSM121 can be mounted inside a sealed-end metal tube, and can then be dipped into a bath or screwed into a threaded hole in a tank. As with any IC, the aSM121 and accompanying wiring and circuits must be kept insulated and dry to avoid leakage and corrosion. This is especially true if the circuit may operate at cold temperatures where condensation can occur. Printed-circuit coatings and varnishes such as Humiseal and epoxy paint or dips can be used to ensure that moisture cannot corrode the aSM121 or its connections.



# **Typical Performance Characteristics**

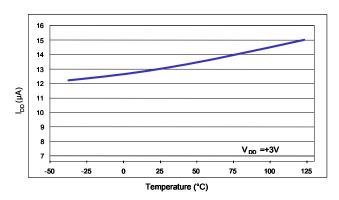


Figure 2. aSM121 Current vs Temperature

# **Typical Applications**

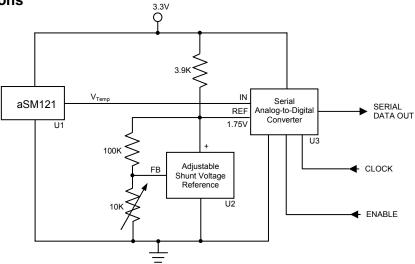


Figure 3. Serial Output Temperature to Digital Converter (Full Scale = +125°C)



# **Typical Applications (cont.)**

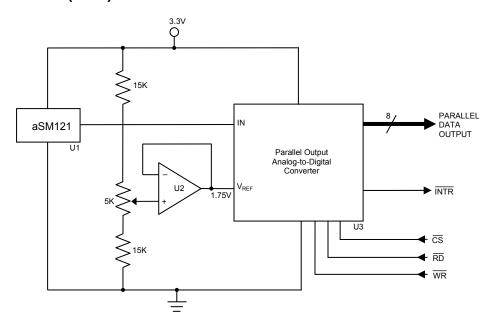


Figure 4. Parallel Output Temperature to Digital Converter (Full Scale = +125°C)

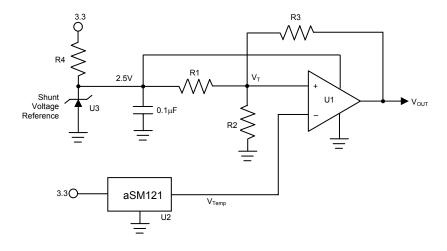
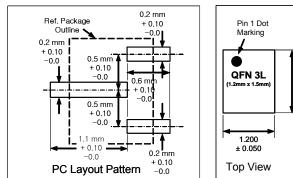
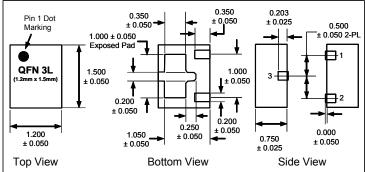


Figure 5. Thermostat / Fan Controller



### QFN-3 Package Dimensions and PC Layout Pattern





Note: Solder mask is recommended to be 0.07mm larger than PC lands.

Figure 6. Package Outline

# **Tape and Reel Data**

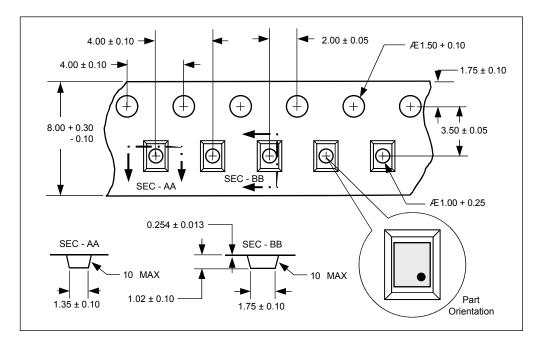


Figure 7. Tape Dimensions and Part Orientation



#### **Data Sheet Classifications**

#### **Preliminary Specification**

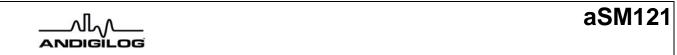
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Notes:

Andigilog, Inc. 8380 S. Kyrene Rd., Suite 101 Tempe, Arizona 85284-2120 Tel: (480) 940-6200 Fax: (480) 940-4255